PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE: NEW ASSIGNMENT

NATURE OF CONVEYANCE: ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Tung-Hsien Hsieh	11/16/2007

RECEIVING PARTY DATA

Name:	MediaTek Inc.	
Street Address:	No. 1, Dusing Rd. 1st, Science-Based Industrial Park	
City:	Hsin-Chu	
State/Country:	TAIWAN	
Postal Code:	300	

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	12880859	

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER: 251314-4951

NAME OF SUBMITTER: Daniel R. McClure

Total Attachments: 2

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> PATENT REEL: 024978 FRAME: 0116

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ASSIGNMENT

WILKI	eas, <u>run</u>	g-risien ri	PIEU
			as/have invented certain new and useful improvements as lentified application for United States Letters Patent:
Title: <u>SEMIC</u> SAME	ONDUCTOR	CHIP PAG	CKAGE AND METHOD FOR DESIGNING THE
Filed:		,	Serial No.
Executed on:	November 1	6, 2007	

WHEREAS, MediaTek Inc. of No. 1, Dusing Rd. 1st, Science-Based Industrial Park, Hsin-Chu 300, Taiwan, R.O.C. hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

MTKI-07-222A/0758-A33248US

PATENT REEL: 024978 FRAME: 0117 Tung-Heien Heieh

Tung-Heien HSIEH

200). Nov. 16

MTKI-07-222A/0758-A33248US

RECORDED: 09/13/2010

PATENT REEL: 024978 FRAME: 0118